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Patent

Customer No.: 31561  
Application No.: 10/710,662  
Docket No. 12336-US-PA

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of

Applicant : Jui-Tsen Huang  
Application No. : 10/710,662  
Filed : July 27, 2004  
For : METHOD OF RELIEVING WAFER STRESS  
Art Unit : 2813  
Examiner : HARRISON, MONICA D

**TRANSMITTAL LETTER**

+1-571-273-8300

(Via fax: 1+2+10 pages)

ASSISTANT COMMISSIONER FOR PATENTS  
Alexandria, VA 22314

Dear Sir,

In response to the Final Office Action dated April 27, 2007, please find the relevant papers as follows:

- ☒ Request for Continued Examination in (2) pages;
- ☒ Preliminary Amendment in (10) pages.

Thank you for your assistance in the subject matter. If you have any questions, please feel free to contact me.

Respectfully Submitted,  
JIANQ CHYUN Intellectual Property Office

Date: July 23, 2007

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